



ESD SMD Comm COG, Ceramic, 6,800 pF, 5%, 250 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1206, 1.5 mm



General Information	
Series	ESD SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features	Temperature Stable, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	15 mg
Shelf Life	78 Weeks
MSL	1

1206
3.2mm +/-0.2mm
1.6mm +/-0.2mm
0.78mm +/-0.10mm
1.5mm MIN
0.5mm +/-0.25mm

•	0.7611111 - 7 0.16111111
S	1.5mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	
Packaging	Bulk, Bag

Packaging Quantity

Specifications	
Capacitance	6,800 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	250 VDC
ESD Level per AEC-Q200	25,000 V ESD Level
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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